Octal transceiver with direction pin, 30 Ω series termination resistors; 5 V tolerant input/output; 3-state

Rev. 5 — 4 November 2011

Product data sheet

1. General description

The 74LVC2245A is a octal transceiver featuring non-inverting 3-state bus compatible outputs in both send and receive directions.

A send/receive (DIR) input controls direction, and an output enable (\overline{OE}) input makes easy cascading possible. Pin \overline{OE} controls the outputs so that the buses are effectively isolated.

It is a high-performance, low-power, low-voltage, Si-gate CMOS device and superior to most advanced CMOS compatible TTL families.

The device is designed with 30 Ω series termination resistors in both HIGH and LOW output stages to reduce line noise.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V and 5 V applications.

2. Features and benefits

- 5 V tolerant inputs/outputs, for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low-power consumption
- Direct interface with TTL levels
- Integrated 30 Ω termination resistors
- Complies with JEDEC standard:
 - JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

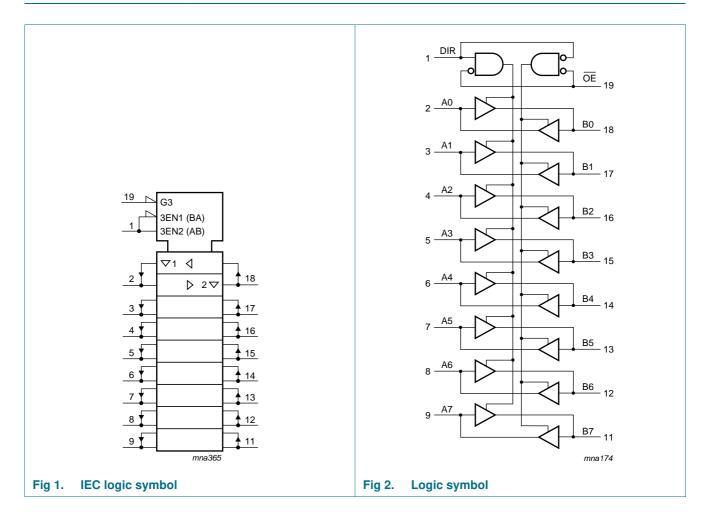


Octal transceiver with direction pin, 30 Ω series termination resistors

Ordering information 3.

Type number	Package						
	Temperature Name range		Description	Version			
74LVC2245AD	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-			
74LVC2245ADB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-			
74LVC2245APW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-			
74LVC2245ABQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm	SOT764-			

4. Functional diagram

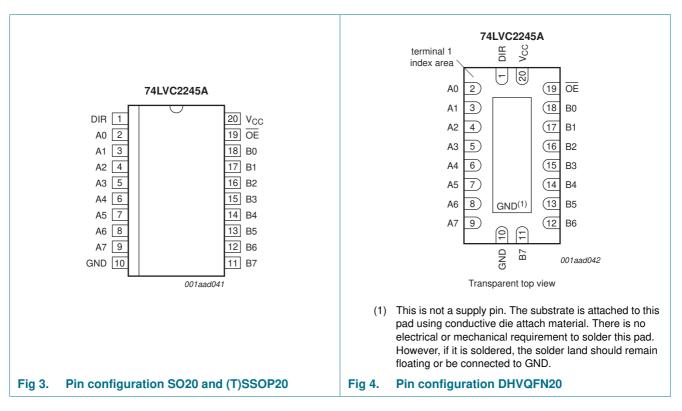


74LVC2245A **Product data sheet**

74LVC2245A

Octal transceiver with direction pin, 30 Ω series termination resistors

Pinning information 5.



5.1 Pinning

5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
DIR	1	direction control input
A[0:7]	2, 3, 4, 5, 6, 7, 8, 9	data input/output
GND	10	ground (0 V)
B[0:7]	18, 17, 16, 15, 14, 13, 12, 1	1 data input/output
OE	19	output enable input (active LOW)
V _{CC}	20	supply voltage

Functional description 6.

Table 3.	Functional table		
Input		Input/output	
OE	DIR	An	Bn
LOW	LOW	A = B	input
LOW	HIGH	input	B = A
HIGH	don't care	Z (high-impedance OFF-st	ate) Z (high-impedance OFF-state)

74LVC2245A Product data sheet

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

			0	.0	,
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V	-	±50	mA
Vo	output voltage	output HIGH or LOW state	<u>[2]</u> –0.5	$V_{CC} + 0.5$	V
		output 3-state	<u>[2]</u> –0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$	[3] _	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SO20 packages: above 70 °C derate linearly with 8 mW/K.
 For (T)SSOP20 packages: above 60 °C derate linearly with 5.5 mW/K.
 For DHVQFN20 packages: above 60 °C derate linearly with 4.5 mW/K.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	V _{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature		-40	-	+125	°C
$\Delta t/\Delta V$ input transition and fall rate	input transition rise	V_{CC} = 1.65 V to 2.7 V	0	-	20	ns/V
	and fall rate	$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	–40 °C to +85 °C			–40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
V _{IH}	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		$V_{CC} = 2.3 \text{ V}$ to 2.7 V	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	۷
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	0.8	-	0.8	۷
V _{OH} HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$							
	output voltage	I _O = -100 μA; V _{CC} = 1.65 V to 3.6 V	$V_{CC}-0.2$	V_{CC}	-	$V_{CC}-0.3$	-	V
		I _O = −2 mA; V _{CC} = 1.65 V	1.2	-	-	1.05	-	٧
		$I_{O} = -4 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -6 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -9 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
	$I_{O} = -12 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V	
/ _{OL}	OL LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	I _O = 100 μA; V _{CC} = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V
		I _O = 2 mA; V _{CC} = 1.65 V	-	-	0.45	-	0.65	٧
		$I_{O} = 4 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_{O} = 6 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_{O} = 12 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
I	input leakage current	V_{CC} = 3.6 V; V_{I} = 5.5 V or GND	-	±0.1	±5	-	±20	μA
oz	OFF-state output current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{IH} \text{ or } V_{IL}; \ V_{CC} = 3.6 \ V; \\ V_{O} = 5.5 \ V \text{ or } GND; \end{array}$	-	±0.1	±5	-	±20	μA
OFF	power-off leakage current	V_{CC} = 0 V; V ₁ or V ₀ = 5.5 V	-	±0.1	±10	-	±20	μA
сс	supply current	$\label{eq:VCC} \begin{array}{l} V_{CC} = 3.6 \ \text{V}; \ \text{V}_{\text{I}} = \text{V}_{CC} \ \text{or GND}; \\ \text{I}_{O} = 0 \ \text{A} \end{array}$	-	0.1	10	-	40	μA
VICC	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_I = V_{CC} - 0.6 V; I_O = 0 A$	-	5	500	-	5000	μA
Cı	input capacitance	$V_{CC} = 0 V \text{ to } 3.6 V;$ $V_I = GND \text{ to } V_{CC}$	-	4.0	-	-	-	pF

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

Octal transceiver with direction pin, 30 Ω series termination resistors

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

Symbol	Parameter	Conditions		T _{amb} =	Γ _{amb} = -40 °C to +85 °C		–40 °C to +125 °C		Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{pd}	propagation delay	An to Bn; Bn to An; see Figure 5	[2]						
		V _{CC} = 1.2 V		-	26	-	-	-	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		1.8	7.5	17.1	1.8	18.0	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	3.9	8.4	1.5	9.4	ns
		$V_{CC} = 2.7 V$		1.5	3.9	7.3	1.5	9.5	ns
		V_{CC} = 3.0 V to 3.6 V		1.5	3.3	6.3	1.5	8.0	ns
t _{en}	enable time	OE to An or Bn; see Figure 6	[2]						
		V _{CC} = 1.2 V		-	28	-	-	-	ns
		V _{CC} = 1.65 V		2.5	9.5	18.8	2.5	21.0	ns
		V_{CC} = 2.3 V to 2.7 V		2.1	5.3	10.3	2.1	11.5	ns
		$V_{CC} = 2.7 V$		1.5	5.4	9.5	1.5	12.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.5	4.2	8.2	1.5	10.5	ns
t _{dis}	disable time	OE to An or Bn; see Figure 6	[2]						
		V _{CC} = 1.2 V		-	12.0	-	-	-	ns
		V _{CC} = 1.65 V		3.0	5.0	10.2	3.0	11.0	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.8	5.8	1.0	6.3	ns
		$V_{CC} = 2.7 V$		1.5	3.6	6.9	1.5	9.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.7	3.3	5.9	1.7	7.5	ns
t _{sk(o)}	output skew time	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns
C _{PD}	power dissipation	$V_I = GND$ to V_{CC}	[4]						
	capacitance	$V_{CC} = 1.65 \text{ V}$ to 1.95 V		-	7.7	-	-	-	pF
		V_{CC} = 2.3 V to 2.7 V		-	11.3	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	14.4	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

t_{en} is the same as t_{PZL} and t_{PZH}.

 t_{dis} is the same as t_{PLZ} and t_{PHZ} .

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz, f_o = output frequency in MHz,

 C_L = output load capacitance in pF,

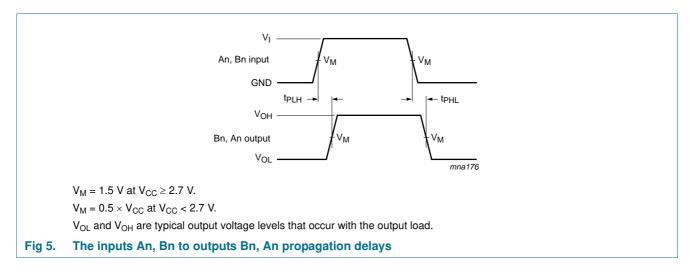
V_{CC} = supply voltage in Volts,

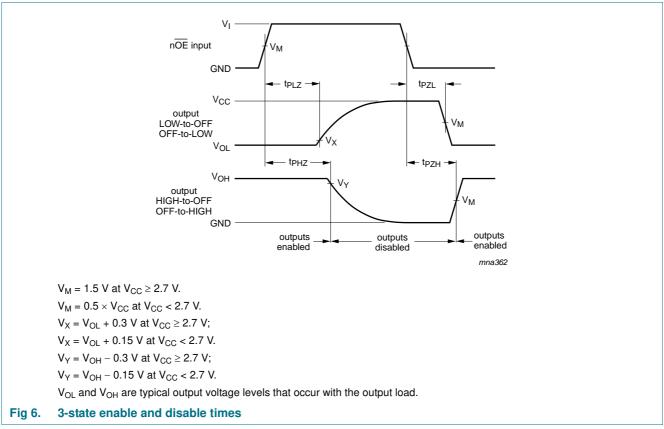
N = number of inputs switching,

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs.

Octal transceiver with direction pin, 30 Ω series termination resistors

11. AC waveforms





74LVC2245A Product data sheet

7 of 16

74LVC2245A

Octal transceiver with direction pin, 30 Ω series termination resistors

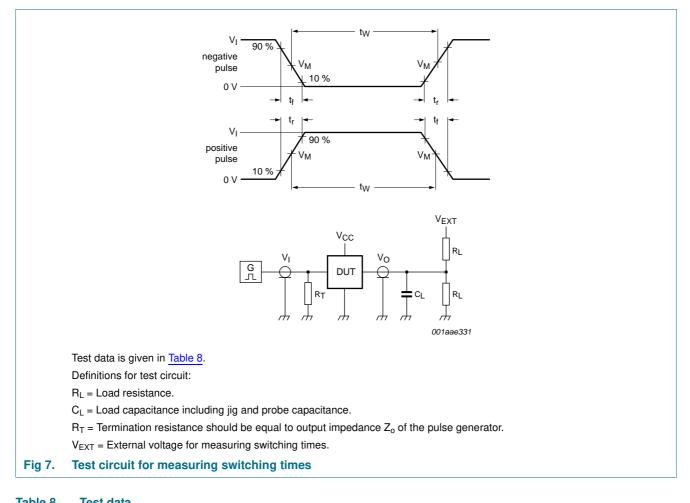


Table 6. Test data								
Supply voltage	Input	Input		Load		V _{EXT}		
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND	
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	

74LVC2245A Product data sheet

74LVC2245A

Octal transceiver with direction pin, 30 Ω series termination resistors

12. Package outline

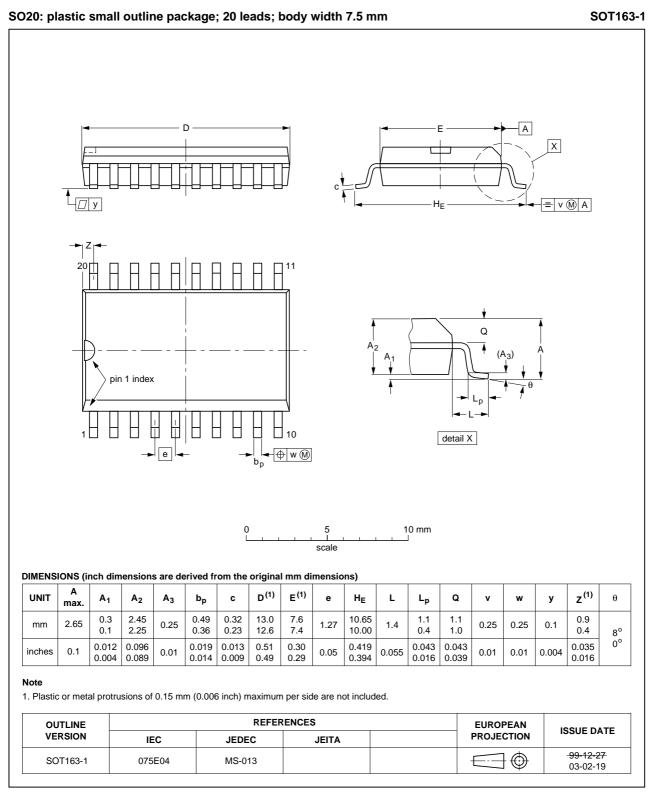


Fig 8. Package outline SOT163-1 (SO20)

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Octal transceiver with direction pin, 30 Ω series termination resistors

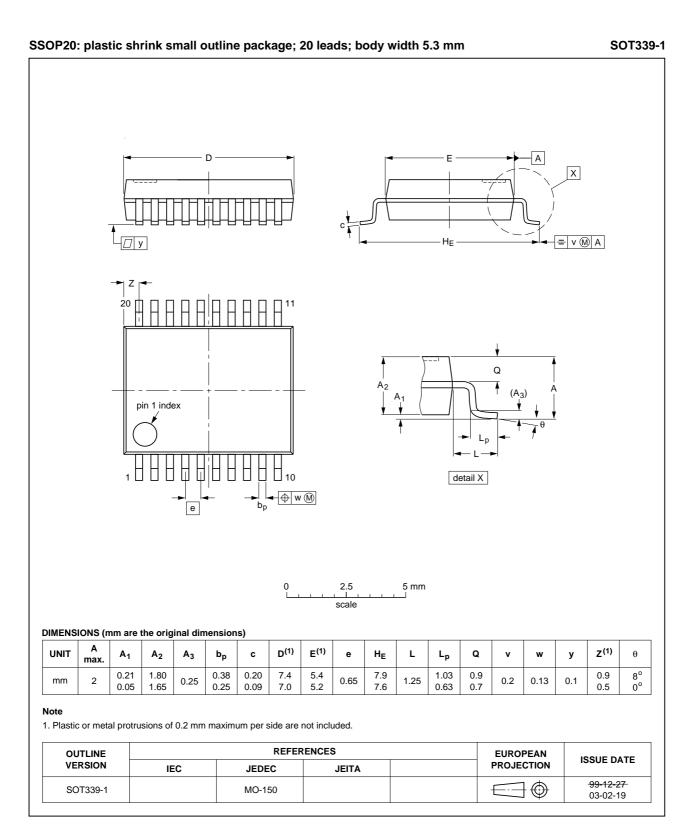


Fig 9. Package outline SOT339-1 (SSOP20)

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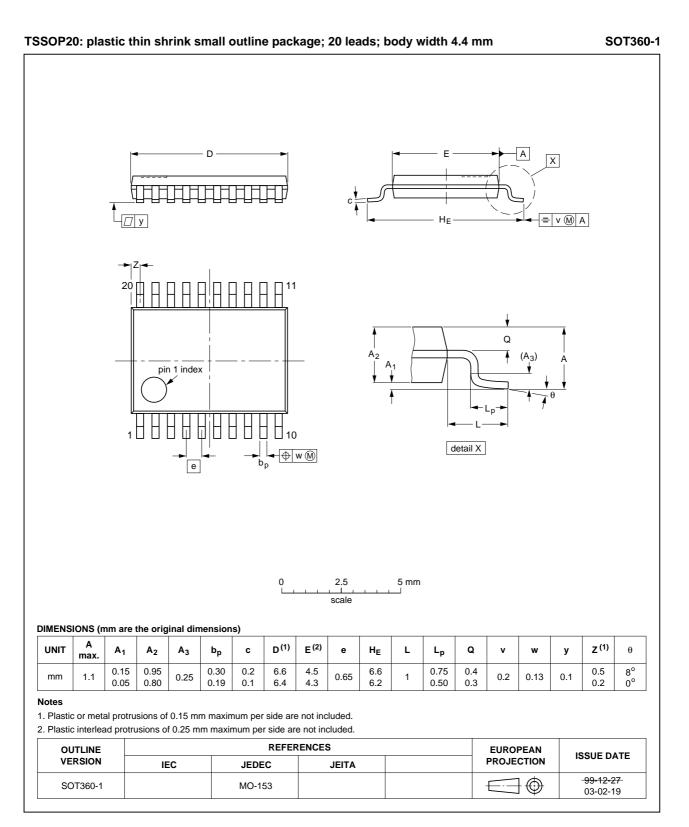
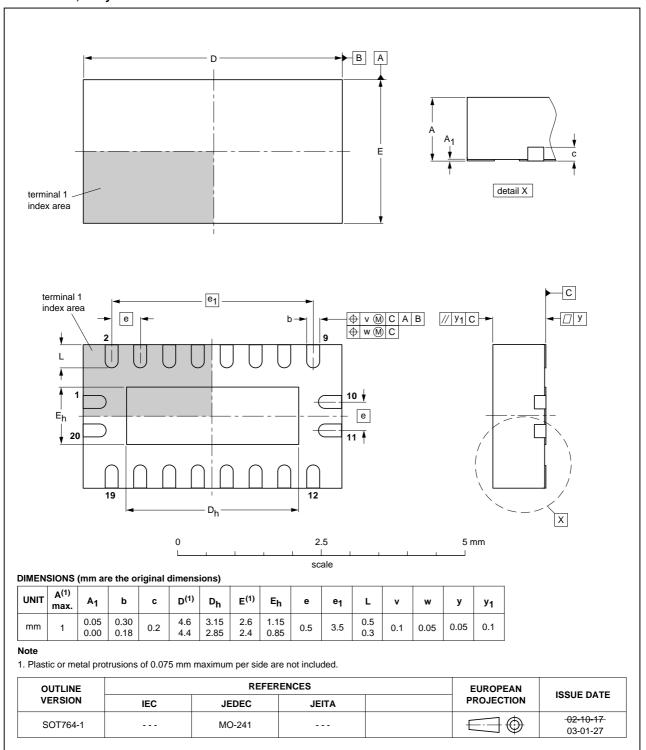


Fig 10. Package outline SOT360-1 (TSSOP20)

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DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

Fig 11. Package outline SOT764-1 (DHVQFN20)

13. Abbreviations

Table 9.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 10. Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC2245A v.5	20111104	Product data sheet	-	74LVC2245A v.4
Modifications:		this document has been rec NXP Semiconductors.	designed to comply	with the new identity
	 Legal texts hat 	ve been adapted to the nev	v company name w	here appropriate.
	• <u>Table 4</u> , <u>Table</u> ranges.	5, <u>Table 6</u> , <u>Table 7</u> and <u>Tab</u>	o <mark>le 8</mark> : values added	for lower voltage
74LVC2245A v.4	20031117	Product specification	-	74LVC2245A v.3
74LVC2245A v.3	20020610	Product specification	-	74LVC2245A v.2
74LVC2245A v.2	19990615	Product specification	-	74LVC2245A v.1
74LVC2245A v.1	19990323	Product specification	-	-

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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74LVC2245A

Octal transceiver with direction pin, 30 Ω series termination resistors

17. Contents

1	General description 1
2	Features and benefits 1
3	Ordering information 2
4	Functional diagram 2
5	Pinning information 3
5.1	Pinning
5.2	Pin description 3
6	Functional description 3
7	Limiting values 4
8	Recommended operating conditions 4
9	Static characteristics 5
10	Dynamic characteristics 6
11	AC waveforms 7
12	Package outline 9
13	Abbreviations 13
14	Revision history 13
15	Legal information 14
15.1	Data sheet status 14
15.2	Definitions 14
15.3	Disclaimers
15.4	Trademarks 15
16	Contact information 15
17	Contents 16

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